# DM74AS832B Hex 2-Input OR Driver

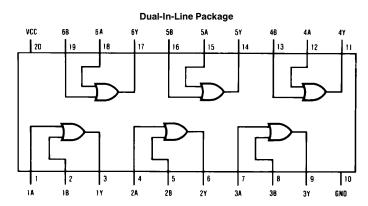
#### **General Description**

These devices contain six independent drivers, each of which performs the logic OR function. Each driver has increased output drive capability to allow the driving of high capacitive loads.

#### **Features**

- Switching specifications at 50 pF
- Switching specifications guaranteed over full temperature and V<sub>CC</sub> range
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin for pin compatible with Schottky and low power Schottky TTL counterpart
- Improved AC performance over Schottky and low power Schottky counterparts

## **Connection Diagram**



Order Number DM74AS832BWM or DM74AS832BN See NS Package Number M20B or N20A

#### **Function Table**

$$\mathbf{Y} = \mathbf{A} + \mathbf{B}$$

Inputs		Output		
Α	В	Y		
L	L	L		
L	Н	н		
Н	L	Н		
Н	Н	н		

 $\mathsf{H} \,=\, \mathsf{High}\,\,\mathsf{Logic}\,\,\mathsf{Level}$ 

L = Low Logic Level

TL/F/6329-1

## **Absolute Maximum Ratings**

Supply Voltage 7V
Input Voltage 7V
Operating Free Air Temperature Range 0°C to +70°C
Storage Temperature Range -65°C to +150°C

Typical  $\theta_{\mathsf{JA}}$ 

N Package 58.3°C/W M Package 154.0°C/W

Note: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the "Electrical Characteristics" table are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

## **Recommended Operating Conditions**

Symbol	Parameter	Min	Nom	Max	Units
V <sub>CC</sub>	Supply Voltage	4.5	5	5.5	V
V <sub>IH</sub>	High Level Input Voltage	2			V
V <sub>IL</sub>	Low Level Input Voltage			0.8	V
I <sub>OH</sub>	High Level Output Current			-48	mA
I <sub>OL</sub>	Low Level Output Current			48	mA
T <sub>A</sub>	Free Air Operating Temperature	0		70	°C

#### **Electrical Characteristics**

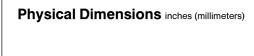
over recommended operating free air temperature range. All typical values are measured at  $V_{CC}=5V$ ,  $T_A=25^{\circ}C$ .

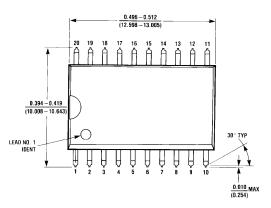
			• •				
Symbol	Parameter	Conditions		Min	Тур	Max	Units
$V_{IK}$	Input Clamp Voltage	$V_{CC} = 4.5V$ , $I_{I} = -18 \text{ mA}$				-1.2	V
V <sub>OH</sub>	High Level Output	$I_{OH} = -2 \text{ mA}, V_{CC} = 4.5 \text{V to } 5.5 \text{V}$		V <sub>CC</sub> – 2			
	Voltage	tage $I_{OH} = -3 \text{ mA}, V_{CO}$		2.4			V
		$I_{OH} = Max, V_{CC} = 4.5V$		2			
V <sub>OL</sub>	Low Level Output Voltage	$V_{CC} = 4.5V$ , $I_{OL} = Max$			0.35	0.5	V
I <sub>I</sub>	Input Current at Max Input Voltage	$V_{CC} = 5.5V, V_{IH} = 7V$				0.1	mA
I <sub>IH</sub>	High Level Input Current	$V_{CC} = 5.5V, V_{IH} = 2.7V$				20	μΑ
I <sub>IL</sub>	Low Level Input Current	$V_{CC} = 5.5V, V_{IL} = 0.4V$				-0.5	mA
lo	Output Drive Current	$V_{CC} = 5.5V, V_{O} = 2.25V$		-50	-135	-200	mA
Icc	Supply Current	$V_{CC} = 5.5V$	Outputs High		11	17	mA
			Outputs Low		22	36	mA

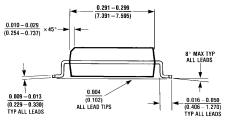
### Switching Characteristics over recommended operating free air temperature range (Note 1)

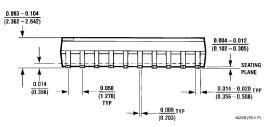
Symbol	Parameter	Conditions	Min	Max	Units
t <sub>PLH</sub>	Propagation Delay Time Low to High Level Output	$V_{CC}=4.5V$ to $5.5V$ $R_L=500\Omega$ $C_L=50$ pF	1	6.3	ns
t <sub>PHL</sub>	Propagation Delay Time High to Low Level Output		1	6.3	ns

Note 1: See Section 5 for test waveforms and output load.



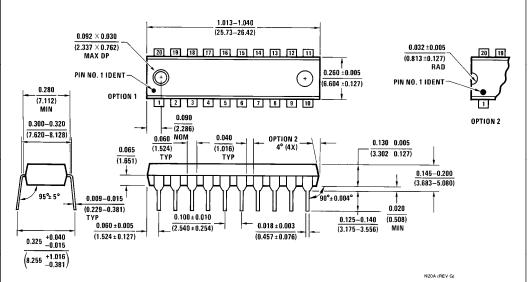






S.O. Package (M) Order Number DM74AS832BWM NS Package Number M20B

### Physical Dimensions inches (millimeters) (Continued)



Molded Dual-In-Line Package (N) Order Number DM74AS832BN NS Package Number N20A

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